Tyrone Camarero Specifications

Camerero: SDI200F0A-48

Key Feature

- Support CXL
- 5th/4th Gen Intel® Xeon® Scalable processors, Dual Socket LGA-4677 (Socket E), CPU TDP supports up to 350W TDP
- Intel® C741 Chipset
- Up to 4TB 3DS ECC RDIMM, DDR5-5600MT/s(1DPC) in 16 DIMM slots
- Broadcom BCM57416 Dual ports 10G LAN
- 2 SATA DOM ports
- 2 M 2
- 4 NVMe ports PCle 5.0 x4 via 2 MCIO connectors
- 5 PCle 5.0 x16, 1 PCle 5.0 x8
- 8 SATA 3.0 ports(C741, RAID 0, 1, 5, 10)
- HD Audio 7.1 channel
- 1 USB 3.1 Gen 2, 6 USB 3.0
- Support 8 x 3.5"/2.5"(SATA)+2x 2.5"(SSD) Fix disks
- Support Single width 4 GPUs and Dual Width 2GPUs
- Cabinet with 3 x 2500 Mid Fan, 1 x Rear Fan
- FSP 1200W Single/Redundant Power Supply
- Closed Loop Liquid Cooling for CPUs of upto 250W TDP







Processor/Cache

Processor 5th/4th Gen Intel® Xeon® Scalable

processors, Dual Socket LGA-4677 (Socket E), CPU TDP supports up to 350W TDP

Chipset

Chipset Intel® C741 Chipset

System Memory

Memory Capacity Up to 4TB 3DS ECC RDIMM, DDR5-5600MT/s(1DPC) in 16 DIMM

slots

Expansion Slot

PCI-Express 1 PCIe 5.0 x8, 5 PCIe 5.0 x16, M.2 Interface: 2

PCIe 5.0 x4

Integrated Onboard:

SATA 8 SATA3 ports; RAID 0, 1, 5, 10

2 SATA3 ports; RAID 0,1

Add-on Options

Raid Card Optional

Optical Drive Optional

Drive bays

Drive bays Support 8 x 3.5"/2.5"(SATA)+2x

2.5"(SSD) Fix disks

Power Supply

Power Supply FSP 1200W Single/Redundant Power

Supply

Cooling System

Cabinet with 3 x 2500 Mid Fan, 1 x Rear Fan

Form Factor

Form Factor 4U Rackmount

Email: Info@tyronesystems.com
For more/current product information, Visit
www.tyronesystems.com

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